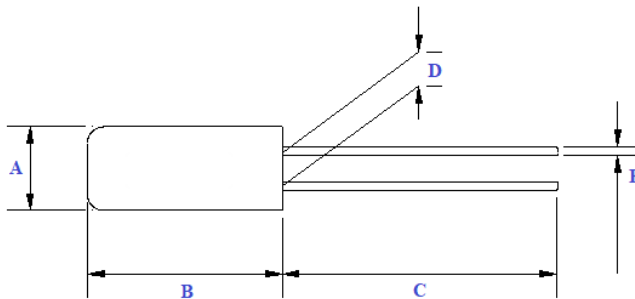


Mechanical Details



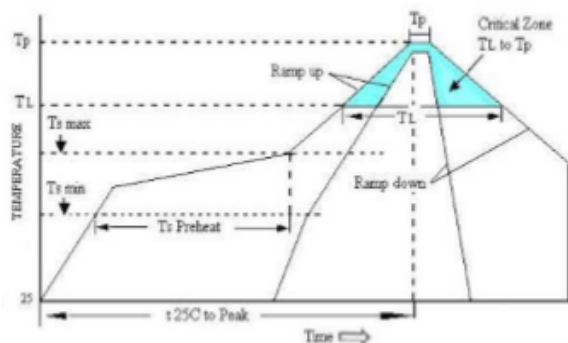
Dimension Table	
A	Ø 2.1 MAX
B	6.2 MAX
C	5.7 MIN
D	0.7 ± 0.2
E	Ø 0.25 ± 0.1

Sealing Method = Pressure Sealing

Tape & Reel Dimensions

1,000 pcs/bag

Pb Free Solder Reflow Profile



Ts max to T _L (Ramp-up Rate)	3°C / second max
Preheat	
Temperature min (Ts min)	150°C
Temperature typ (Ts typ)	175°C
Temperature max (Ts max)	200°C
Time (Ts)	60 to 180 seconds
Ramp-up Rate (T _L to Tp)	3°C / second max
Time Maintained Above Temperature (T _L)	217°C
Time (T _L)	60 to 150 seconds
Peak Temperature (Tp)	260°C max for 10 seconds
Time within 5°C to Peak Temperature (Tp)	20 to 40 seconds
Ramp-down Rate	6°C / second max
Time 25°C to Peak Temperature	8 minutes max

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